

US00D348247S

United States Patent [19].

Cooper

[11] Patent Number: Des. 348,247

[45] Date of Patent: ** Jun. 28, 1994

[54]	ELECTRONIC CIRCUIT HOUSING				
[75]	Inventor:	David Cooper, Seattle, Wash.			
[73]	Assignee:	Eldec Corporation, Lynnwood, Wash.			
[**]	Term:	14 Years			
[21]	Appl. No.:	9,360			
[22]	Filed:	Jun. 9, 1993			
Related U.S. Application Data					
[62]	Division of Ser. No. 954,930, Sep. 29, 1992.				

[62]	Division of Ser. No. 954,930, Sep. 29, 1992.
[52]	U.S. Cl D13/110
[58]	Field of Search 361/111, 386, 388, 392
	361/395; 336/90, 92, 200; 363/15, 95; 307/150
	151; 174/52.1, 52.2; D13/110, 123, 124, 184
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Primary Examiner—Wallace R. Burke
Assistant Examiner—Joel Sincavage
Attorney, Agent, or Firm—Christensen, O'Connor,
Johnson & Kindness

[57] CLAIM

The ornamental design for an electronic circuit housing, as shown and described.

DESCRIPTION

FIG. 1 is a top front perspective view of an electronic circuit housing showing my new design;

FIG. 2 is a bottom plan view thereof;

FIG. 3 is an end elevational view thereof taken from the left of FIG. 2, the opposite end thereof being the mirror image of the end shown in FIG. 3;

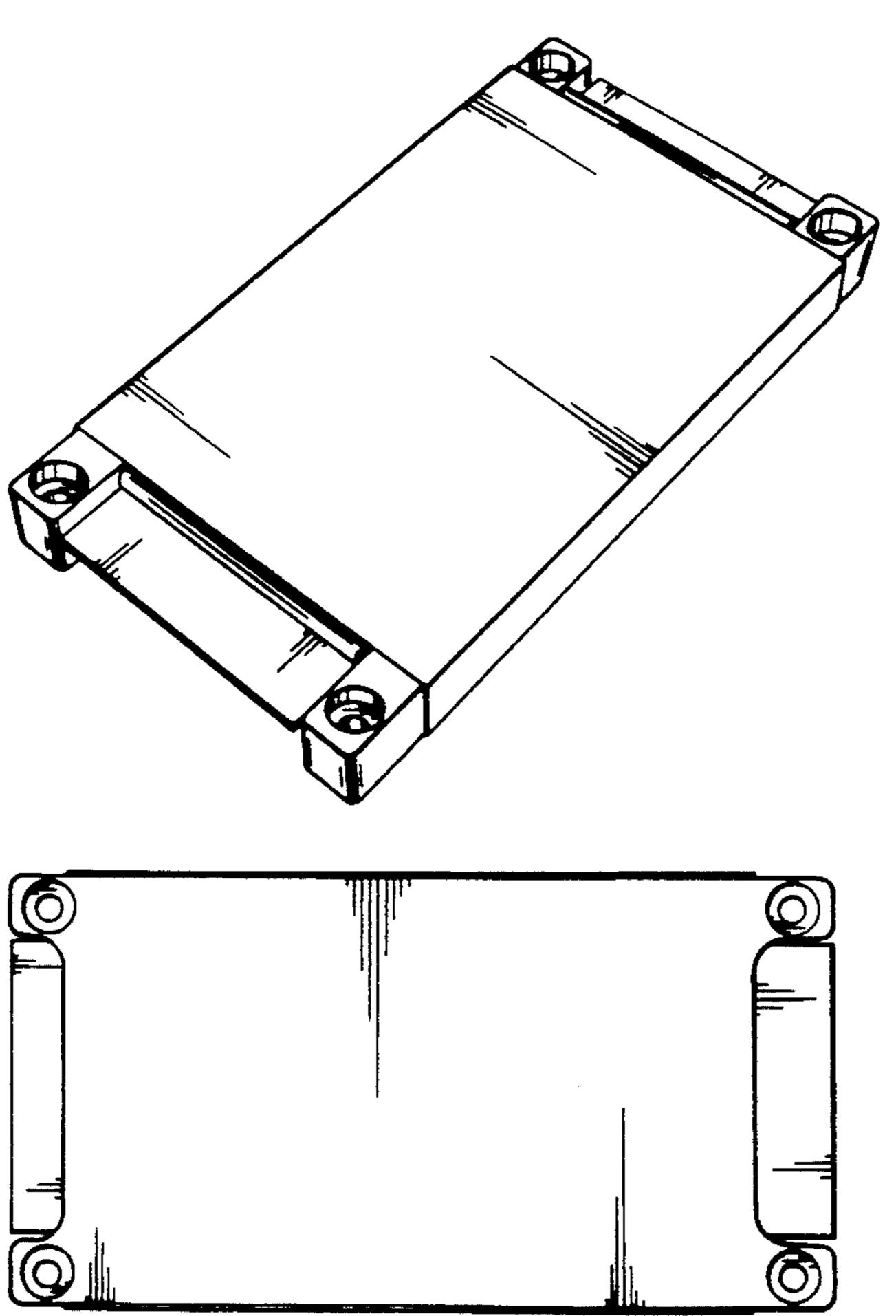
FIG. 4 is a rear elevational view thereof;

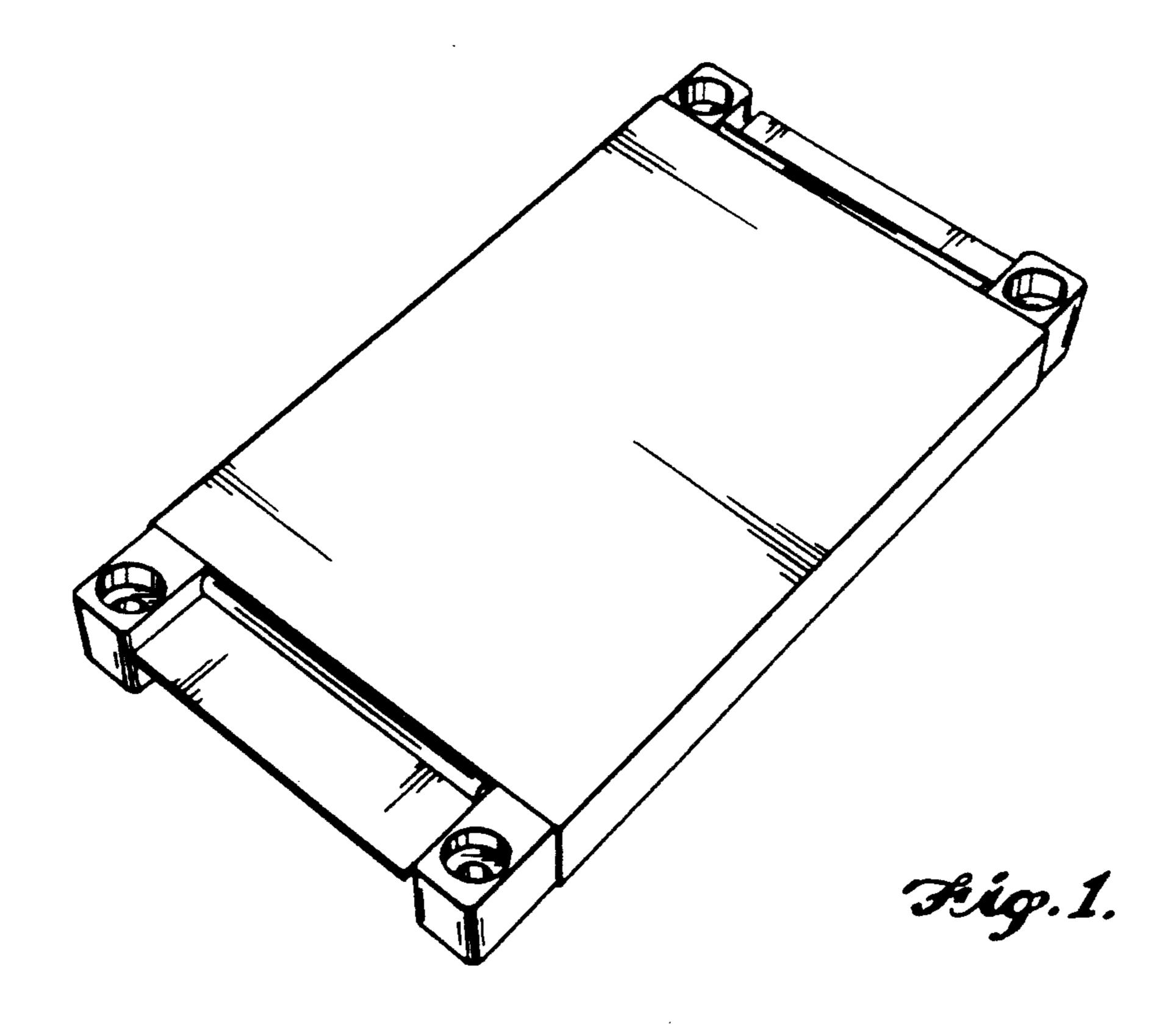
FIG. 5 is a top front perspective of a second embodiment thereof;

FIG. 6 is a bottom plan view of the second embodiment thereof;

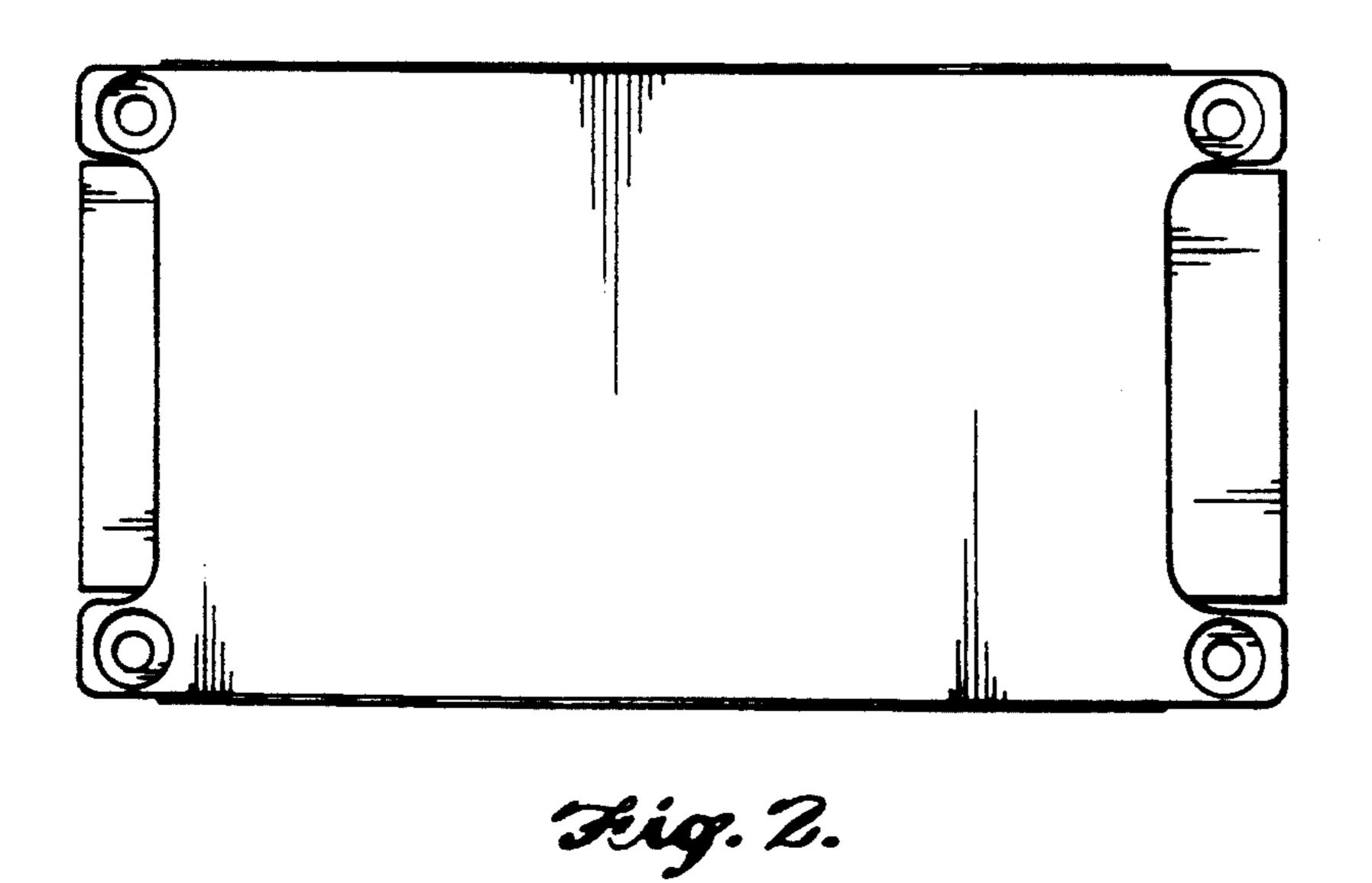
FIG. 7 is an end elevational view of the second embodiment thereof taken from the left of FIG. 6, the opposite end thereof being the mirror image of the end shown in FIG. 7; and,

FIG. 8 is a rear elevational view of the second embodiment thereof.



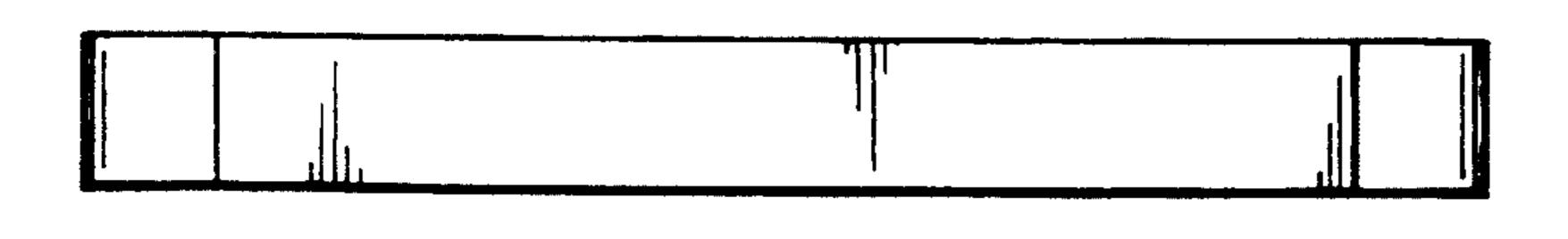


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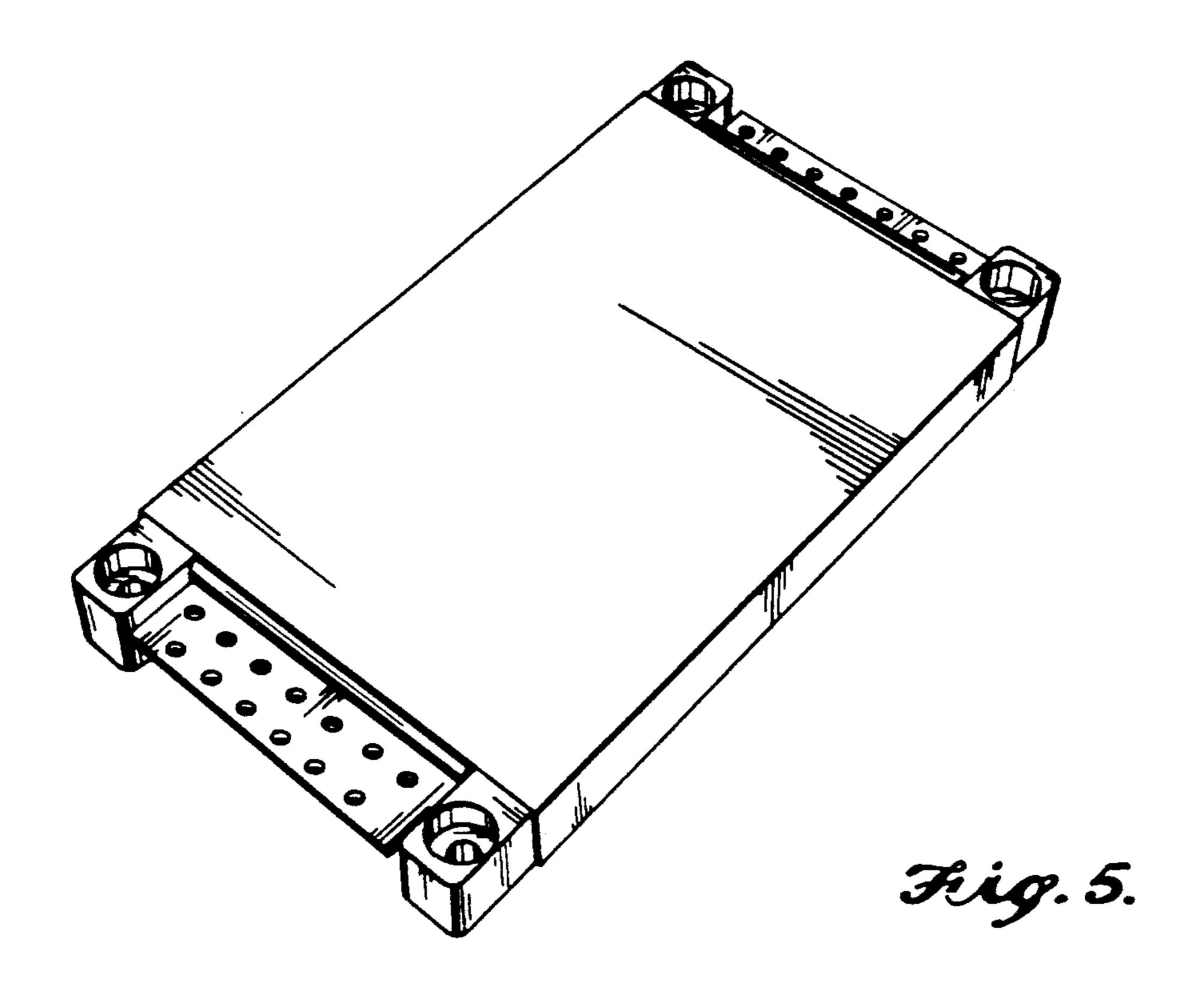


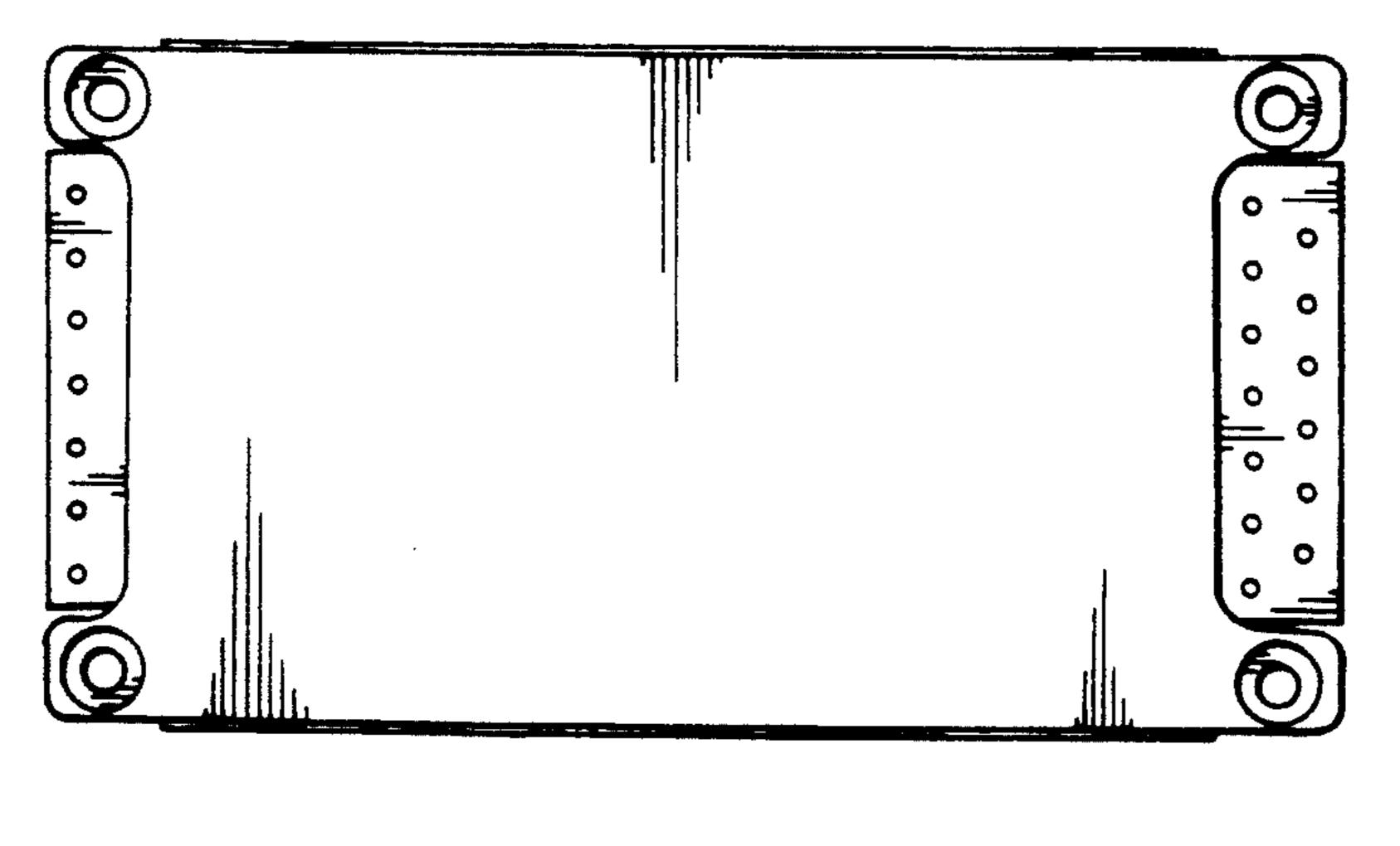


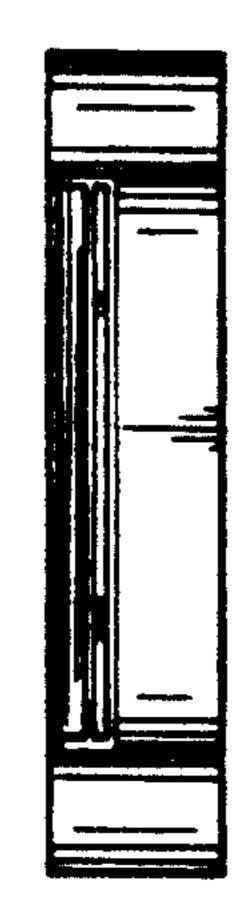
Hig. 3.



Hig. 4.







Hig. 6.

Fig. 7.

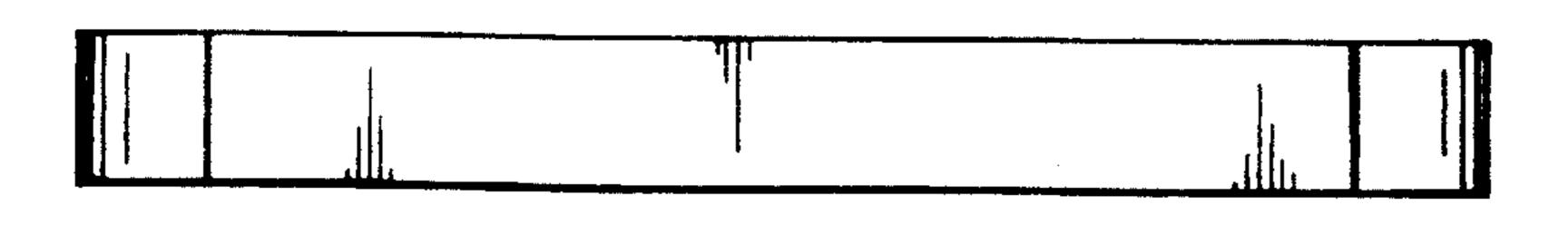


Fig. 8.